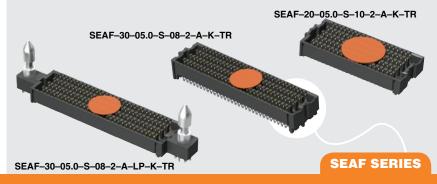


# **SEARAY**

(1.27 mm) .050"



# HIGH-SPEED/HIGH-DENSITY OPEN-PIN-FIEI

#### **SPECIFICATIONS**

For complete specifications and recommended PCB layouts see www.samtec.com?SEAF

Insulator Material: Contact Material: Copper Alloy Operating Temp Range: -55 °C to +125 °C Current Rating (7 mm stack height):

2.7 A per pin (10 adjacent pins powered)

Plating: Au or Sn over 50 µ" (1.27 µm) Ni Working Voltage: 240 VA

RoHS Compliant: Yes (-2 Solder type only) Lead-Free Solderable:

#### RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



#### **STANDARDS**

- VITA 47
- VITA 57.1 FMC
- VITA 57.4 FMC+
- VITA 74 VNX
- PISMO™2

Visit www.samtec.com/standards for more information.

### **DIFFERENTIAL** SIGNAL ROUTING



The above signal routing configuration allows for the use of 25 to 125 differential pair counts. Contact sig@samtec.com for specific details.

#### Notes:

IPC-A-610F and IPC J-STD-001F Class 3 solder joint.

Some sizes, styles and options are non-standard, non-returnable.



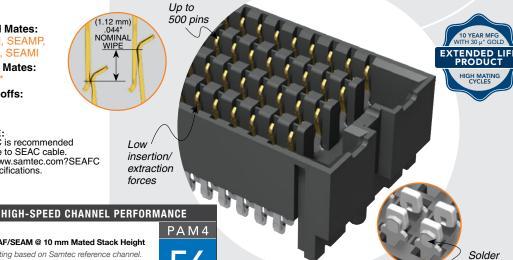
**Cable Mates:** 

Standoffs:

SEAF

\*NOTE: SEAFC is recommended to mate to SEAC cable. Visit www.samtec.com?SEAFC

for specifications.



SEAF/SEAM @ 10 mm Mated Stack Height

Rating based on Samtec reference channel. For full SI performance data visit Samtec.com or contact SIG@samtec.com

PER ROW

NO. PINS **LEAD** 

PLATING **OPTION** 

NO. OF **ROWS** 

SOLDER **TYPE** 

OPTION



charges

## ·10, –15, –20 -30, –40, –50 (–10 only available in 04 row)

(-15 only available in 04 or 10 row with -05.0 lead style)

NO. OF ROWS	В
-04	(5.66) .223
-05, -06	(8.20) .323
-08	(10.74) .423
-10	(13.28) .523

В

(1.27) .050

**LEAD STYLE** from chart

LEAD

STYLE

STYLE	Α
-05.0	(5.05) .199
-06.0	(6.05) .238
-06.5	(6.55) .258
-07.5	(7.54) .297

<del>(</del>1.27) .050 

No. of positions x (1.27) .050 + (5.82) .229

No. of positions x (1.27) .050 + (3.58) .141

←(1.12) .044 DIA

 $= 10 \mu$ " (0.25 µm) Gold on contact area, Matte Tin on

solder tail

-S
= 30 µ"
(0.76 µm)
Gold on
contact
area,
Matte Tin on
solder tail

-04 =Four Rows -05

=Five Rows -06 =Six Rows

-08 =Eight Rows -10 =Ten

Rows

-LP

- 1 = Tin/Lead Alloy Solder Charge

**-2** Lead-Free Solder Charge

(15.49)

.610 (1.78) .070

-LP = Latch Post (-LP required for SEAC

mate only)
(Available with –05.0 lead style and -04, -06, -08 & -10 rows only)

–TR = Tape & Reel

-FR = Full Reel

Tape & Reel Packaging (Must order màx. quantities per reel. Contact Samtec for

parts per reel)

### **POWER/SIGNAL** APPLICATION



.009 Due to technical progress, all designs, specifications and components are subject to change without notice

WWW.SAMTEC.COM